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N-Channel Power MOSFET 620 V, 1.2 Ω

Features

- Low ON Resistance
- Low Gate Charge
- ESD Diode-Protected Gate

Rating

- 100% Avalanche Tested
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Symbol NDF06N62Z

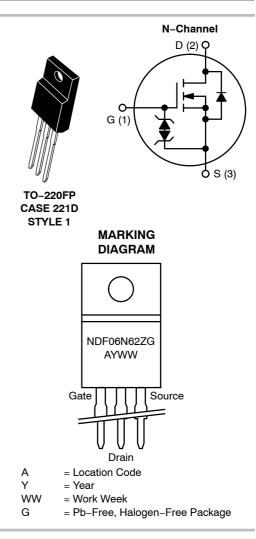
Unit



ON Semiconductor®

http://onsemi.com

| V _{DSS} | R _{DS(ON)} (MAX) @ 3 A |
|------------------|---------------------------------|
| 620 V | 1.2 Ω |



ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

| Drain-to-Source Voltage | V _{DSS} | 620 | V |
|--|-----------------------------------|------------|------|
| Continuous Drain Current $R_{\theta JC}$ (Note 1) | I _D | 6.0 | А |
| Continuous Drain Current $R_{\theta JC}$, $T_A = 100^{\circ}C$ (Note 1) | Ι _D | 3.8 | A |
| Pulsed Drain Current, V _{GS} @ 10 V | I _{DM} | 20 | A |
| Power Dissipation $R_{\theta JC}$ | PD | 31 | W |
| Gate-to-Source Voltage | V _{GS} | ±30 | V |
| Single Pulse Avalanche Energy, $I_D = 6.0$ A | E _{AS} | 113 | mJ |
| ESD (HBM) (JESD 22-A114) | V _{esd} | 3000 | V |
| RMS Isolation Voltage (t = 0.3 sec., R.H. \leq 30%, T _A = 25°C) (Figure 14) | V _{ISO} | 4500 | V |
| Peak Diode Recovery (Note 2) | dv/dt | 4.5 | V/ns |
| Continuous Source Current (Body Diode) | ۱ _S | 6.0 | А |
| Maximum Temperature for Soldering Leads | ΤL | 260 | °C |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to 150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Limited by maximum junction temperature

2. I_{SD} = 6.0 A, di/dt \leq 100 A/µs, V_{DD} \leq BV_{DSS}, T_J = +150 ^{\circ}C

ORDERING INFORMATION

| Device | | Package | Shipping |
|-----------|---|--|-----------------|
| NDF06N62Z | G | TO-220FP (Pb-Free, Halogen-Free) | 50 Units / Rail |

1

THERMAL RESISTANCE

| Parameter | Symbol | NDF06N62Z | Unit |
|---|-----------------|-----------|------|
| Junction-to-Case (Drain) | R_{\thetaJC} | 4.0 | °C/W |
| Junction-to-Ambient Steady State (Note 3) | $R_{\theta JA}$ | 50 | |

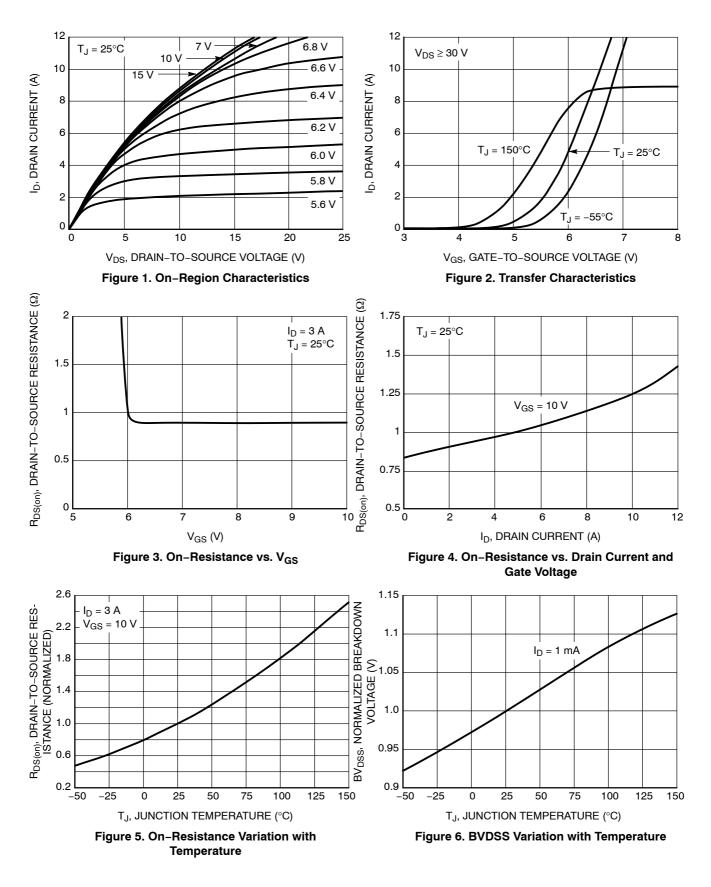
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

| Characteristic | Test Conditions | | Symbol | Min | Тур | Max | Unit |
|--|---|-------|-------------------------------|-----|------|-----|------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$ | A | BV _{DSS} | 620 | | | V |
| Breakdown Voltage Temperature Coefficient | Reference to 25°C, $I_D = 1 \text{ mA}$ | | $\Delta BV_{DSS}/ \Delta T_J$ | | 0.6 | | V/°C |
| Drain-to-Source Leakage Current | | 25°C | I _{DSS} | | | 1 | μA |
| | V_{DS} = 620 V, V_{GS} = 0 V | 125°C | | | | 50 | |
| Gate-to-Source Forward Leakage | $V_{GS} = \pm 20 \text{ V}$ | • | I _{GSS} | | | ±10 | μA |
| ON CHARACTERISTICS (Note 4) | | | | | | | |
| Static Drain-to-Source On-Resistance | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.0 \text{ J}$ | A | R _{DS(on)} | | 0.98 | 1.2 | Ω |
| Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 100 \mu$ | ιA | V _{GS(th)} | 3.0 | | 4.5 | V |
| Forward Transconductance | $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.0 \text{ J}$ | A | 9 _{FS} | | 5.0 | | S |
| OYNAMIC CHARACTERISTICS | | | | | | | |
| Input Capacitance | | _ | C _{iss} | | 923 | | pF |
| Output Capacitance | V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz | | C _{oss} | | 106 | | 1 |
| Reverse Transfer Capacitance | | | C _{rss} | | 23 | | |
| Total Gate Charge | V _{DD} = 310 V, I _D = 6.0 A, | | Qg | | 32 | | nC |
| Gate-to-Source Charge | | | Q _{gs} | | 6.3 | | 1 |
| Gate-to-Drain ("Miller") Charge | V _{GS} = 10 V | | Q _{gd} | | 17 | | |
| Plateau Voltage | | | V _{gp} | | 6.3 | | V |
| Gate Resistance | | | R _g | | 3.2 | | Ω |
| RESISTIVE SWITCHING CHARACTERI | STICS | | | | | | |
| Turn–On Delay Time | V _{DD} = 310 V, I _D = 6.0 A, | | t _{d(on)} | | 13 | | ns |
| Rise Time | | | t _r | | 19 | | 1 |
| Turn-Off Delay Time | $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 5 \Omega$ | 2 | t _{d(off)} | | 32 | | 1 |
| Fall Time | | | t _f | | 28 | | 1 |

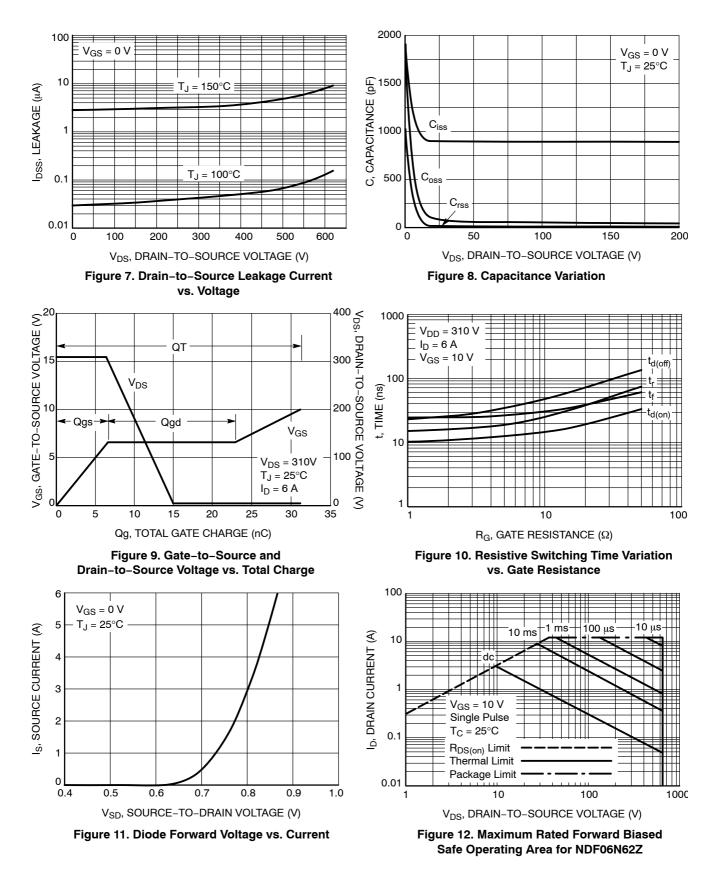
| Diode Forward Voltage | $I_{\rm S}$ = 6.0 A, $V_{\rm GS}$ = 0 V | V _{SD} | | 1.6 | V |
|-------------------------|--|-----------------|-----|-----|----|
| Reverse Recovery Time | $V_{GS} = 0 V, V_{DD} = 30 V$ | t _{rr} | 338 | | ns |
| Reverse Recovery Charge | $I_{S} = 6.0 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ | Q _{rr} | 2.0 | | μC |

3. Insertion mounted 4. Pulse Width \leq 380 µs, Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

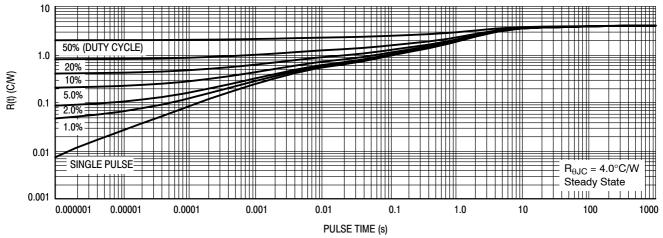
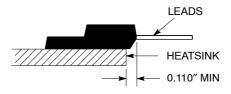


Figure 13. Thermal Impedance for NDF06N62Z



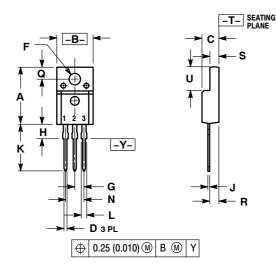


Measurement made between leads and heatsink with all leads shorted together.

*For additional mounting information, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TO-220FP CASE 221D-03 **ISSUE K**



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH

221D-01 THRU 221D-02 OBSOLETE, NEW 3. STANDARD 221D-03

| | INC | HES | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.617 | 0.635 | 15.67 | 16.12 | |
| В | 0.392 | 0.419 | 9.96 | 10.63 | |
| С | 0.177 | 0.193 | 4.50 | 4.90 | |
| D | 0.024 | 0.039 | 0.60 | 1.00 | |
| F | 0.116 | 0.129 | 2.95 | 3.28 | |
| G | 0.100 BSC | | 2.54 | BSC | |
| Н | 0.118 | 0.135 | 3.00 | 3.43 | |
| J | 0.018 | 0.025 | 0.45 | 0.63 | |
| Κ | 0.503 | 0.541 | 12.78 | 13.73 | |
| L | 0.048 | 0.058 | 1.23 | 1.47 | |
| Ν | 0.200 BSC | | 5.08 | BSC | |
| Q | 0.122 | 0.138 | 3.10 | 3.50 | |
| R | 0.099 | 0.117 | 2.51 | 2.96 | |
| S | 0.092 | 0.113 | 2.34 | 2.87 | |
| U | 0.239 | 0.271 | 6.06 | 6.88 | |

STYLE 1: PIN 1. GATE

2. DRAIN SOURCE 3.

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